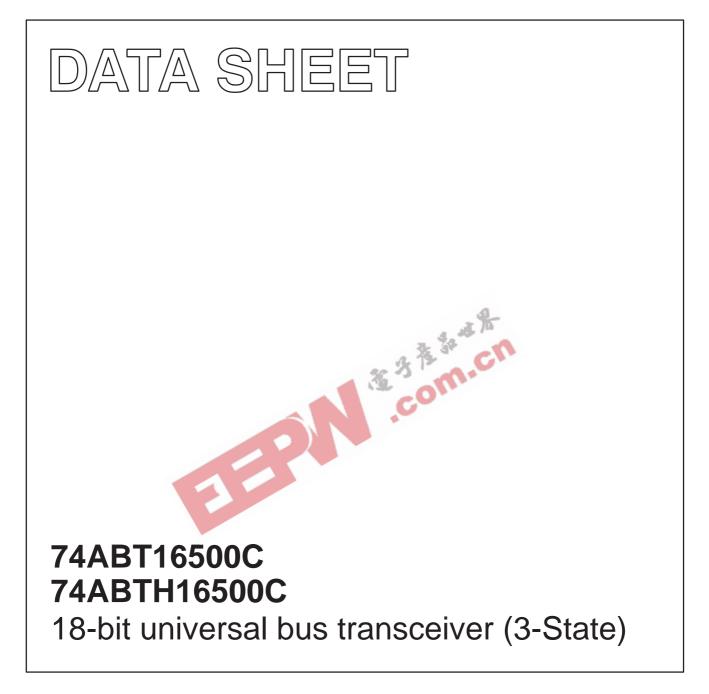
INTEGRATED CIRCUITS



Product specification Supersedes data of 1997 Jun 12 IC23 Data Handbook 1998 Feb 27



74ABT16500C 74ABTH16500C

FEATURES

- 18-bit bidirectional bus interface
- 3-State buffers
- 74ABTH16500C incorporates bus-hold data inputs which eliminate the need for external pull-up resistors to hold unused inputs
- Output capability: +64mA/-32mA
- TTL input and output switching levels
- Live insertion/extraction permitted
- Power-up reset
- Power-up 3-State
- Negative edge-triggered clock inputs
- Latch-up protection exceeds 500mA per JEDEC Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 200V per Machine Model
- Flexible operation permits 18 embedded D-type latches or flip-flops to operate in clocked, transparent, or latched modes.

DESCRIPTION

The 74ABT16500C is a high-performance BiCMOS Device which combines low static and dynamic power dissipation with high speed and high output drive.

This device is an 18-bit universal transceiver featuring non-inverting 3-State bus compatible outputs in both send and receive directions. Data flow in each direction is controlled by output enable (OEAB and OEBA), latch enable (LEAB and LEBA), and clock (CPAB and CPBA) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is High. When LEAB is Low, the A data is latched if CPAB is held at a High or Low logic level. If LEAB is Low, the A-bus data is stored in the latch/flip-flop on the High-to-Low transition of CPAB. When OEAB is High, the outputs are active. When OEAB is Low, the outputs are in the high-impedance state.

Data flow for B-to-A is similar to that of A-to-B but uses \overline{OEBA} , LEBA and \overline{CPBA} . The output enables are complimentary (OEAB is active High, and \overline{OEBA} is active Low).

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

Two options are available, 74ABT16500C which does not have the bus-hold feature and 74ABTH16500C which incorporates the bus-hold feature.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay An to Bn or Bn to An	C _L = 50pF; V _{CC} = 5V	2.1 1.7	ns
C _{IN}	Input capacitance (Control pins)	$V_I = 0V \text{ or } V_{CC}$	3	pF
C _{I/O}	I/O pin capacitance	Outputs disabled; $V_{I/O} = 0V$ or V_{CC}	7	pF
I _{CCZ}	Quiescent supply current	Outputs disabled; $V_{CC} = 5.5V$	500	μΑ
I _{CCL}	Quescent supply current	Outputs low; $V_{CC} = 5.5V$	8	mA

ORDERING INFORMATION

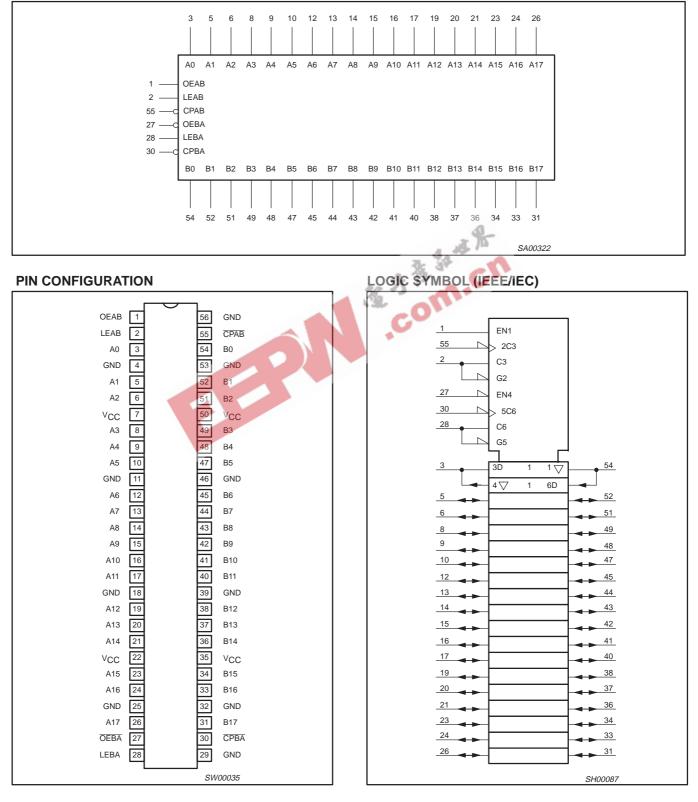
PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
56-Pin Plastic SSOP Type III	-40°C to +85°C	74ABT16500C DL	BT16500C DL	SOT371-1
56-Pin Plastic TSSOP Type II	-40°C to +85°C	74ABT16500C DGG	BT16500C DGG	SOT364-1
56-Pin Plastic SSOP Type III	-40°C to +85°C	74ABTH16500C DL	BH16500C DL	SOT371-1
56-Pin Plastic TSSOP Type II	-40°C to +85°C	74ABTH16500C DGG	BH16500C DGG	SOT364-1

Product specification

18-bit universal bus transceiver (3-State)

74ABT16500C 74ABTH16500C

LOGIC SYMBOL



74ABT16500C 74ABTH16500C

PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1	OEAB	A-to-B Output enable input
27	OEBA	B-to-A Output enable input (active low)
2, 28	LEAB/LEBA	A-to-B/B-to-A Latch enable input
55,30	CPAB/CPBA	A-to-B/B-to-A Clock input (active falling edge)
3, 5, 6, 8, 9, 10, 12, 13, 14, 15, 16, 17, 19, 20, 21, 23, 24, 26	A0-A17	Data inputs/outputs (A side)
54, 52, 51, 49, 48, 47, 45, 44, 43, 42, 41, 40, 38, 37, 36, 34, 33, 31	B0-B17	Data inputs/outputs (B side)
4, 11, 18, 25, 32, 39, 46, 53	GND	Ground (0V)
7, 22, 35, 50	V _{CC}	Positive supply voltage

FUNCTION TABLE

	INP	UTS		Internal	OUTPUTS	OPERATING MODE
OEAB	LEAB	CPAB	An	Registers	Bn	
L	Н	Х	Х	Х	Z	Disabled
L	\downarrow	Х	h	Н	Z	Disabled, Latch data
L	\downarrow	Х	T		Z	Disabled, Lateri data
L	L	H or L	Х	NC	Z	Disabled, Hold data
L	L	\downarrow	h	Н	Z	Dischlad, Clack data
L	L	Ţ		L	Z	Disabled, Clock data
Н	Н	Х	н	Н	Н	Transport
н	н	x	L	L	L	Transparent
Н	\downarrow	Х	h	н	н	Latek data 9 dianlau
н	\downarrow	Х	I	L	L	Latch data & display
Н	L	\downarrow	h	н	н	Olask data 8 diaslav
Н	L	\downarrow	Ι	L	L	Clock data & display
Н	L	H or L	Х	Н	Н	Light data 9 diaplay
н	L	H or L	Х	L	L	Hold data & display

NOTE: A-to-B data flow is shown; B-to-A flow is similar but uses OEBA, LEBA, and CPBA.

H = High voltage level
h = High voltage level one set-up time prior to the Enable or Clock transition

L = Low voltage level

= Low voltage level one set-up time prior to the Enable or Clock transition L

NC= No Change

 $\begin{array}{l} X = \text{Don't care} \\ Z = \text{High Impedance "off" state} \\ \downarrow = \text{High-to-Low Enable or Clock transition} \end{array}$

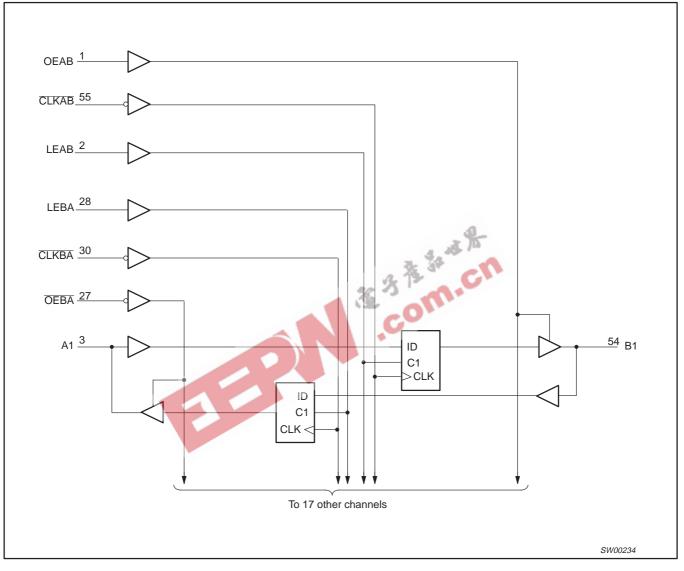
Product specification

74ABT16500C

74ABTH16500C

18-bit universal bus transceiver (3-State)

LOGIC DIAGRAM



UNIT

V

V

V

V

mΑ

mΑ

ns/V

°C

18-bit universal bus transceiver (3-State)

74ABT16500C 74ABTH16500C

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
I _{IK}	DC input diode current	V ₁ < 0	-18	mA
VI	DC input voltage ³		-1.2 to +7.0	V
I _{OK}	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	Output in Off or High state	-0.5 to +5.5	V
		Output in Low state	128	
IOUT	DC output current	Output in High state	-64	mA
T _{stg}	Storage temperature range		-65 to +150	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction 2. temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

m. PARAMETER LIMITS SYMBOL MIN MAX 5.5 DC supply voltage 4.5 V_{CC} VI Input voltage 0 V_{CC} VIH High-level input voltage 2.0 V_{IL} Input voltage 0.8 High-level output current -32 IOH Low-level output current 64 IOL $\Delta t / \Delta v$ Input transition rise or fall rate; Outputs enabled 10 T_{amb} Operating free-air temperature range -40 +85

RECOMMENDED OPERATING CONDITIONS

Product specification

18-bit universal bus transceiver (3-State)

74ABT16500C 74ABTH16500C

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	г	_{amb} = +25	°C	T _{amb} = −40°C to +85°C		
			MIN	ТҮР	MAX	MIN	MAX	
V _{IK}	Input clamp voltage	V _{CC} = 4.5V; I _{IK} = -18mA		-0.8	-1.2		-1.2	V
		V_{CC} = 4.5V; I_{OH} = -3mA; V_I = V_{IL} or V_{IH}	2.5	2.9		2.5		V
V _{OH}	High-level output voltage	V_{CC} = 5.0V; I_{OH} = -3mA; V_I = V_{IL} or V_{IH}	3.0	4.0		3.0		V
		V_{CC} = 4.5V; I_{OH} = -32mA; V_{I} = V_{IL} or V_{IH}		2.4		2.0		V
V _{OL}	Low-level output voltage	V_{CC} = 4.5V; I _{OL} = 64mA; V _I = V _{IL} or V _{IH}		0.35	0.55		0.55	V
V _{RST}	Power-up output voltage ³	V_{CC} = 5.5V; I _O = 1mA; V _I = GND or V _{CC}		0.13	0.55		0.55	V
I _I	Input leakage current	$V_{CC} = 5.5V; V_I = GND \text{ or}$ 5.5V Control pin	5	± 0. 01	±1.0		±1.0	μA
		V _{CC} = 4.5V; V ₁ = 0.8V	35			35		
I _{HOLD}	Bus Hold current A and B Ports ⁶ 74ABTH16500C	$V_{CC} = 4.5 V; V_1 = 2.0 V$		CV		-75		μΑ
		$V_{CC} = 5.5V; V_I = 0 \text{ to } 5.5V$	±800					
I _{OFF}	Power-off leakage current	$V_{CC} = 0.0V; V_O \text{ or } V_I \le 4.5V$		±2	±100		±100	μΑ
I _{PU/PD}	Power-up/down 3-State output current ⁴	$V_{CC} = 2.1V; V_O = 0.0V \text{ or } V_{CC};$ $V_{OE} = Don't care$		±2	±50		±50	μA
I _{IH} + I _{OZH}	3-State output High current	V_{CC} = 5.5V; V_O = 5.5V; V_I = V_{IL} or V_{IH}		1.0	10		10	μΑ
$I_{IL} + I_{OZL}$	3-State output Low current	$V_{CC} = 5.5 \text{V}; V_{O} = 0.0 \text{V}; V_{I} = V_{IL} \text{ or } V_{IH}$		-1.0	-10		-10	μΑ
I _{CEX}	Output High leakage current	$V_{CC} = 5.5$ V; $V_{O} = 5.5$ V; $V_{I} = GND$ or V_{CC}		2	50		50	μΑ
Ι _Ο	Output current ¹	$V_{\rm CC} = 5.5 \text{V}; \text{ V}_{\rm O} = 2.5 \text{V}$	-50	-80	-180	-50	-180	mA
I _{CCH}		V_{CC} = 5.5V; Outputs High, V _I = GND or V _{CC}		0.5	2		2	mA
I _{CCL}	Quiescent supply current	V_{CC} = 5.5V; Outputs Low, V_I = GND or V_{CC}	;	8	19		19	mA
I _{CCZ}		V_{CC} = 5.5V; Outputs 3–State; V _I = GND or V _{CC}		0.5	2		2	mA
ΔI _{CC}	Additional supply current per input pin ² 74ABT16500C	V_{CC} = 5.5V; one input at 3.4V, other inputs at V_{CC} or GND		5.0	50		50	μA
ΔI _{CC}	Additional supply current per input pin ² 74ABTH16500C	V_{CC} = 5.5V; one input at 3.4V, other inputs at V_{CC} or GND		200	500		500	μA

DC ELECTRICAL CHARACTERISTICS

NOTES:

1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

2. This is the increase in supply current for each input at 3.4V.

3. For valid test results, data must not be loaded into the flip-flops (or latches) after applying the power.

4. This parameter is valid for any V_{CC} between 0V and 2.1V, with a transition time of up to 10msec. From V_{CC} = 2.1V to V_{CC} = 5V \pm 10% a transition time of up to 100µsec is permitted.

Unused pins at V_{CC} or GND.
This is the bus hold overdrive current required to force the input to the opposite logic state.

74ABT16500C 74ABTH16500C

AC CHARACTERISTICS

GND = 0V, $t_R = t_F$ = 2.5ns, C_L = 50pF, R_L = 500 Ω

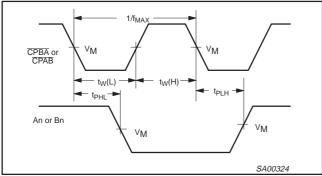
					LIMITS			
SYMBOL	PARAMETER	WAVEFORM	٦	Γ _{amb} = +25° V _{CC} = +5.0∖	с /	T _{amb} = -4 V _{CC} = +5	0 to +85°C .0V ±0.5V	UNIT
			MIN	TYP	MAX	MIN	MAX	
f _{max}	Maximum clock frequency	1	150	225		150		MHz
t _{PLH} t _{PHL}	Propagation delay An to Bn or Bn to An	2	1.0 1.0	2.1 1.7	3.0 2.5	1.0 1.0	3.4 3.0	ns
t _{PLH} t _{PHL}	Propagation delay LEAB to Bn or LEBA to An	3	1.0 1.0	3.2 2.8	4.3 3.7	1.0 1.0	4.9 4.0	ns
t _{PLH} t _{PHL}	Propagation delay CPAB to Bn or CPBA to An	1	1.0 1.0	3.4 2.6	4.5 3.5	1.0 1.0	5.3 4.6	ns
t _{PZH} t _{PZL}	Output enable time to HIGH and LOW level	5 6	1.0 1.5	3.3 2.4	4.4 3.2	1.0 1.5	5.0 3.9	ns
t _{PHZ} t _{PLZ}	Output disable time from HIGH and LOW level	5 6	1.5 1.4	3.3 2.5	4.3 3.3	1.5 1.4	5.3 3.9	ns
	P REQUIREMENTS = $t_F = 2.5ns, C_L = 50pF, R_L = 5$	500Ω	26	为教	C			

AC SETUP REQUIREMENTS

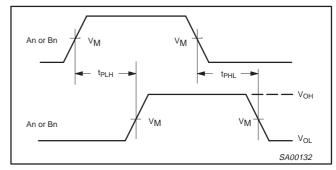
		13		LIN	NITS	
SYMBOL	PARAMETER	WAVEFORM	V _{CC} =	= +25°C = +5.0V	T _{amb} = −40 to +85°C V _{CC} = +5.0V ±0.5V	UNIT
			MIN	TYP	MIN	
$t_{s}(H) \\ t_{s}(L)$	Setup time, HIGH or LOW An to CPAB or Bn to CPBA	4	2.0 2.0	0.7 0.6	2.0 2.0	ns
t _h (H) t _h (L)	Hold time, HIGH or LOW An to CPAB or Bn to CPBA	4	0.7 0.7	-0.5 -0.8	0.7 0.7	ns
$t_{s}(H) \\ t_{s}(L)$	Setup time, HIGH or LOW An to LEAB or Bn to LEBA	4	2.0 2.0	0.1 0.1	2.0 2.0	ns
t _h (H) t _h (L)	Hold time HIGH or LOW An to LEAB or Bn to LEBA	4	0.7 0.7	-0.1 -0.1	0.7 0.7	ns
t _w	Pulse width, HIGH or LOW CPAB or CPBA	1	3	1.2	3	ns
t _w (H)	Pulse width, HIGH LEAB or LEBA	3	3	1.2	3	ns

AC WAVEFORMS

 $V_{M} = 1.5V$, $V_{IN} = GND$ to 3.0V



Waveform 1. Propagation Delay, Clock Input to Output, Clock Pulse Width, and Maximum Clock Frequency

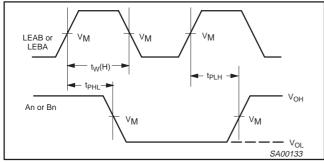


Waveform 2. Propagation Delay, Transparent Mode

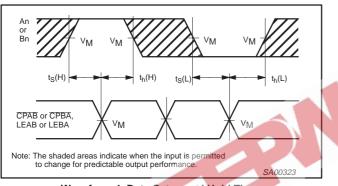
74ABT16500C 74ABTH16500C

AC WAVEFORMS (Continued)

 $V_{M} = 1.5V, V_{IN} = GND \text{ to } 3.0V$



Waveform 3. Propagation Delay, Enable to Output, and Enable **Pulse Width**



Waveform 4. Data Setup and Hold Times

VCC

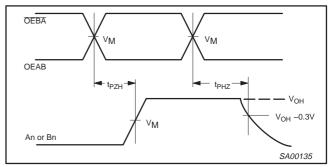
D.U.T

VOUT

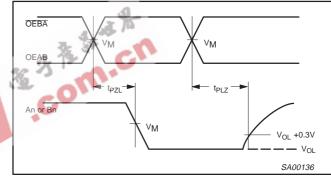
TEST CIRCUIT AND WAVEFORMS

Vin

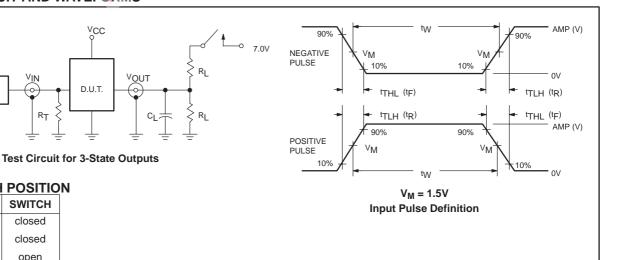
R-



Waveform 5. 3-State Output Enable Time to High Level and Output Disable Time from High Level



Waveform 6. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level



DEFINITIONS

SWITCH POSITION

SWITCH

closed

closed

open

PULSE GENERATOR

TEST

t_{PLZ}

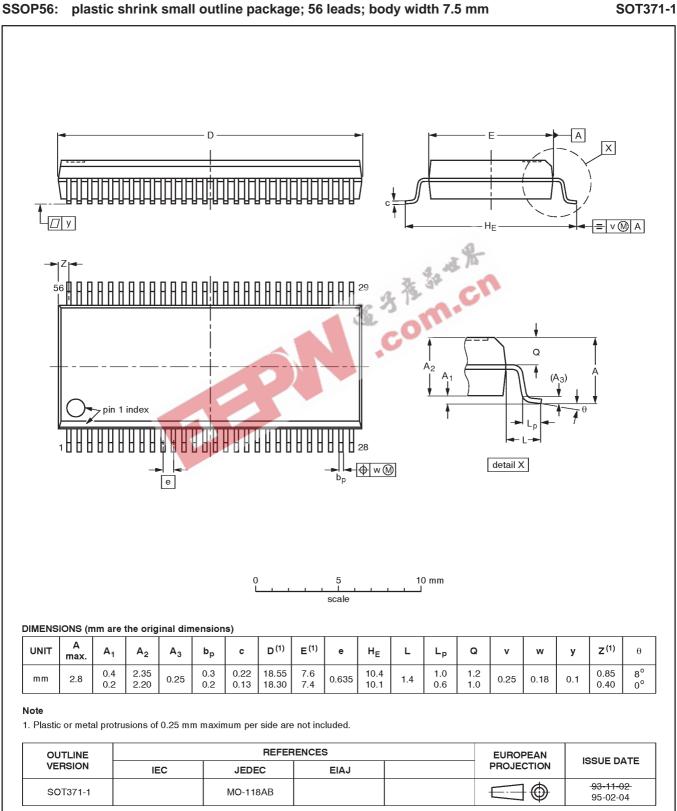
t_{PZL} All other

- R_I = Load resistor; see AC CHARACTERISTICS for value.
- C_L = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.
- $R_T =$ Termination resistance should be equal to ZOUT of pulse generators.

	IN	PUT PULSE R	EQUIRE	MENTS	
FAMILY	Amplitude	Rep. Rate	t _W	t _R	t _F
74ABT/H16	3.0V	1MHz	500ns	2.5ns	2.5ns

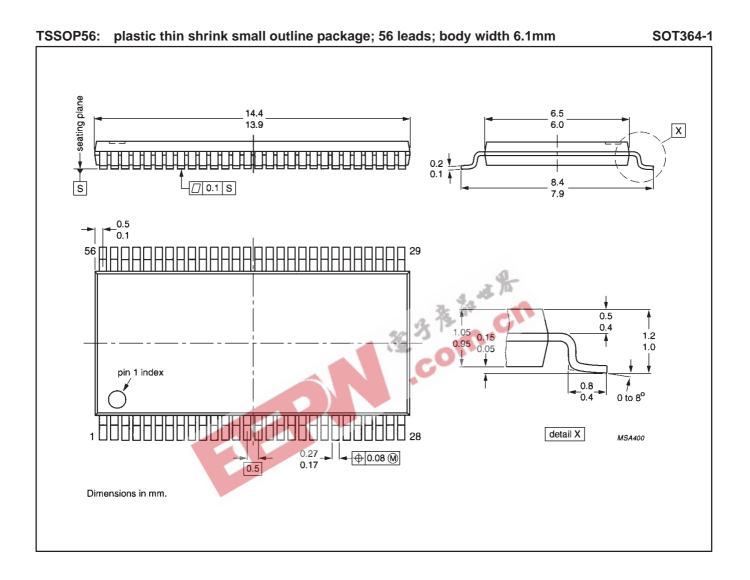
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74ABT16500C 74ABTH16500C



SOT371-1

74ABT16500C 74ABTH16500C



74ABT16500C 74ABTH16500C

Data sheet status

Data sheet status	Product status	Definition ^[1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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